

CubeSat Kit™ I/O LED Module

Hardware Revision: B

LED Display Module for Digital I/O Signals

Applications

CubeSat Kit debugging & testing

Features

- Displays digital status of I/O lines via LEDs
- Provides buffered digital I/O test points
- Maps all 48 CubeSat Kit I/O signals
- Active, buffered circuit design
- Zero-power design via ON/OFF switch
- PC/104-size footprint, with +5V and GND on PC/104 J1/J2 connectors
- 2-layer green-soldermask PCB



ORDERING INFORMATION

Pumpkin P/N 710-00521

Option Code	Configuration
/00 (standard)	standard

Contact factory for availability of optional configurations.

CubeSat Kit Breakout Board Rev. A

CHANGELOG

Rev.	Date	Author	Comments
1	20100604	AEK	Initial Release

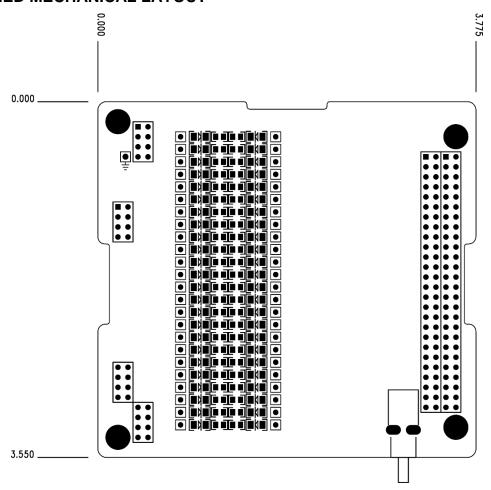
ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Units
Operating temperature	TA	-40 to +85	°С
Operating voltage	Vcc_max	7	V

PHYSICAL CHARACTERISTICS

Parameter	Conditions / Notes	Symbol	Min	Тур	Max	Units
Mass	With vertical boxed headers			51		g
Height of components above PCB	With vertical boxed headers				11	mm
Height of components below PCB ¹					2	mm
PCB width	Corner hale nettern metahas			96		mm
PCB length	Corner hole pattern matches PC/104			90		mm
PCB thickness	FG/104			1.6		mm

SIMPLIFIED MECHANICAL LAYOUT ²



 $^{^{\}rm 1}$ Does not include length of PC/104 stackthrough header pins (H1 & H2) of 10.4mm.

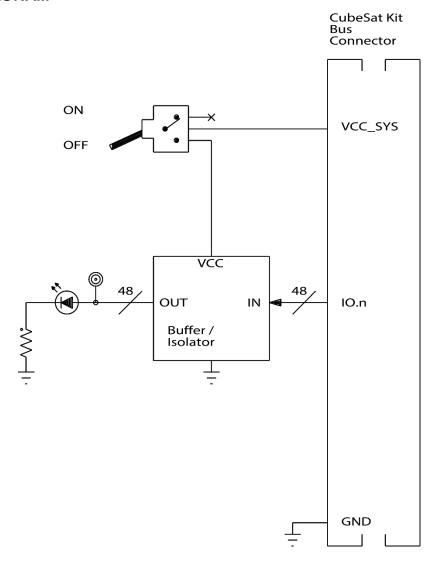
² Dimensions in inches.

ELECTRICAL CHARACTERISTICS

 $(T = 25^{\circ}C, +5V \text{ bus} = +5V \text{ unless otherwise noted})$

Parameter	Conditions / Notes	Symbol	Min	Тур	Max	Units
Operating voltage	From vcc_sys	Vcc	2		5.5	V
	Per LED illuminated, dc	ЮР		8		mA
Operating current	Power switch in down / OFF position	I _{OFF}			1	μA

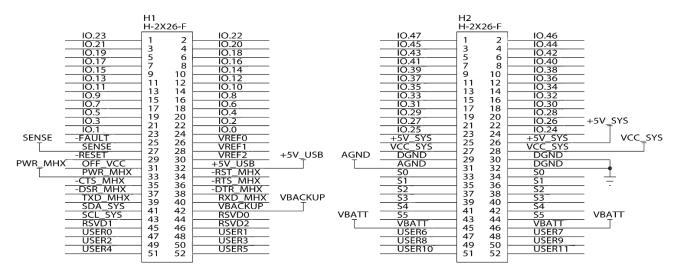
BLOCK DIAGRAM



CubeSat Kit Bus PIN DESCRIPTIONS

The I/O LED Module maps all 48 of the CubeSat Kit's I/O lines IO. [47..0] to individual LEDs. Depending on the Flight Processor used, these signals will map to commonly assigned signals (e.g., UTX0 & URX0) or to customer-specific signals.

CubeSat Kit Bus Connectors



CubeSat Kit Bus PIN DESCRIPTIONS - I/O

Name	Pin	I/O	Description	
10.0	H1.24	I/O	-cs_sd. Controls SD Card interface.	
10.1	H1.23	I/O	SDO0. SPI master data out.	
10.2	H1.22	I/O	SDIO. SPI master data in.	
10.3	H1.21	I/O	SCKO. SPI clock.	
10.4	H1.20	I/O	UTX0. Tx0 data out.	
10.5	H1.19	I/O	urxo. Rxo data in.	
10.6	H1.18	I/O	UTX1. Tx1 data out to MHX transceiver or USB.	
10.7	H1.17	I/O	URX1. Rx1 data in from MHX transceiver or USB.	
10.8	H1.16	I/O	General-purpose I/O.	
10.9	H1.15	I/O	General-purpose I/O.	
IO.10	H1.14	I/O	General-purpose I/O.	
10.11	H1.13	I/O	General-purpose I/O.	
IO.12	H1.12	I/O	General-purpose I/O.	
IO.13	H1.11	I/O	General-purpose I/O.	
IO.14	H1.10	I/O	General-purpose I/O.	
10.15	H1.9	I/O	General-purpose I/O.	
IO.16	H1.8	I/O	General-purpose I/O.	
IO.17	H1.7	I/O	General-purpose I/O.	
IO.18	H1.6	I/O	General-purpose I/O.	
IO.19	H1.5	I/O	General-purpose I/O.	
10.20	H1.4	I/O	General-purpose I/O.	
10.21	H1.3	I/O	General-purpose I/O.	
10.22	H1.2	I/O	General-purpose I/O.	
10.23	H1.1	I/O	General-purpose I/O.	

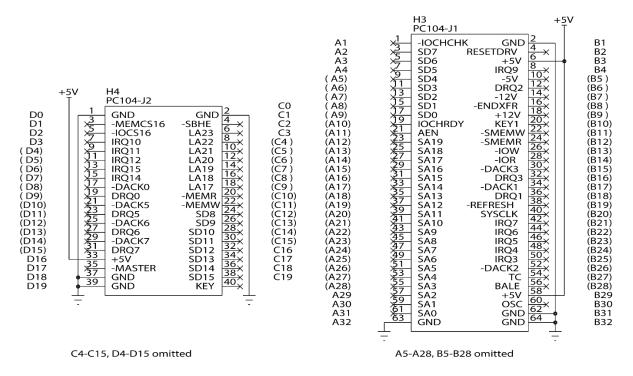
CubeSat Kit Breakout Board Rev. A

IO.24	H2.24	I/O	General-purpose I/O.
10.25	H2.23	I/O	General-purpose I/O.
10.26	H2.22	I/O	General-purpose I/O.
10.27	H2.21	I/O	General-purpose I/O.
IO.28	H2.20	I/O	General-purpose I/O.
10.29	H2.19	I/O	General-purpose I/O.
10.30	H2.18	I/O	General-purpose I/O.
10.31	H2.17	I/O	General-purpose I/O.
10.32	H2.16	I/O	General-purpose I/O.
10.33	H2.15	I/O	General-purpose I/O.
10.34	H2.14	I/O	General-purpose I/O.
10.35	H2.13	I/O	General-purpose I/O.
10.36	H2.12	I/O	General-purpose I/O.
10.37	H2.11	I/O	General-purpose I/O.
10.38	H2.10	I/O	General-purpose I/O.
10.39	H2.9	I/O	General-purpose I/O.
10.40	H2.8	I/O	General-purpose I/O.
IO.41	H2.7	I/O	General-purpose I/O.
10.42	H2.6	I/O	General-purpose I/O.
10.43	H2.5	I/O	General-purpose I/O.
IO.44	H2.4	I/O	General-purpose I/O.
IO.45	H2.3	I/O	General-purpose I/O.
10.46	H2.2	I/O	General-purpose I/O.
IO.47	H2.1	I/O	General-purpose I/O.

PC/104 System Bus PIN DESCRIPTIONS

PC/104 System Bus

Only +5V and GND are implemented.



The I/O LED Module implements a subset of the PC/104 specification in the form of two connectors that provide only +5V and GND for PC/104 modules. Only a total of 32 pins are implemented, 16 on J1 and 16 on J2. By adding up to 4 8-pin connectors to the Breakout Board, PC/104 modules can be plugged directly into the Breakout Board to obtain +5V power and GND. No other connections between the PC/104 bus and the CubeSat Kit Bus are provided.

ZERO-POWER INTERFACE

Each LED on the I/O LED Module is driven via an isolating, non-inverting buffer with partial power-down modes. The toggle switch at the front of the I/O LED Module routes **vcc_sys** to the buffers. When in the down / OFF position, the buffers are unpowered, and their inputs present a high impedance to the CubeSat Kit Bus I/O signals.

TEST POINTS

A labeled test point for every buffered I/O signal is provided.

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744 Naples Street San Francisco, CA 94112 USA tel: (415) 584-6360 fax: (415) 585-7948

web: http://www.pumpkininc.com/ web: http://www.cubesatkit.com/ email: info@cubesatkit.com/